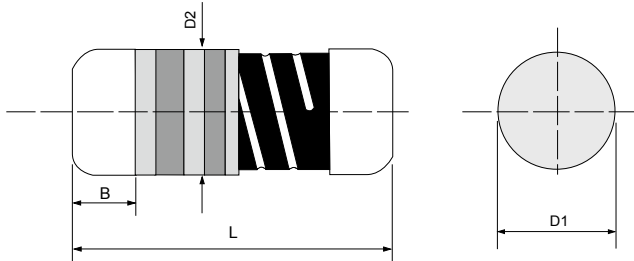


# MMP(V) - Metal Film MELF Precision Resistor, Vehicle Grade

Quality • Reliability  
Cost-Down via Innovation.

MMP(V)



## Specifications Per

- IEC 60115-1
- EN140401-803
- AEC-Q200 Rev. D

## Features

- AEC-Q200 Compliant
- Excellent solderability termination
- Products meet RoHS requirements and do not contain substances of very high concern identified by European Chemicals Agency

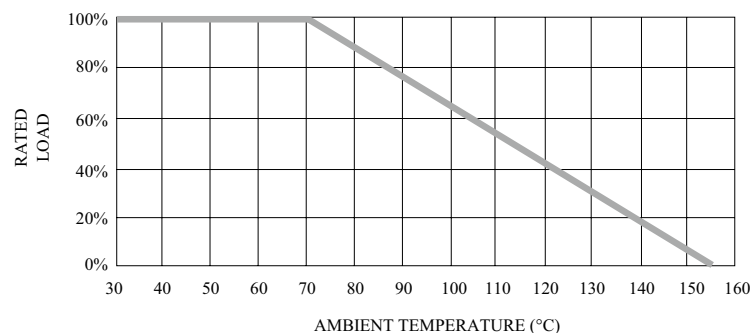
## ■ DIMENSIONS

Type	Body Length (L, mm)	Cap Diameter (D1, mm)	Body Diameter (D2, mm)	Soldering Spot (B, mm)	Net Weight Per 1000 pcs
MMP204V	3.52 ± 0.15	1.35 ± 0.1	D1+0.02/ -0.15	0.6 Min.	17 grams
MMP52V	5.90 ± 0.20	2.20 ± 0.1	D1+0.02/ -0.2	1.0 Min.	66 grams

## ■ GENERAL SPECIFICATIONS

Type	Power Rating (at 70°C)	Maximum Working Voltage	Maximum Overload Voltage	Minimum Resistance	Maximum Resistance	Resistance Tolerance	Available Resistance Values
MMP204V	1/4W	200V	400V	10Ω	1MΩ	±0.5%	E-24/ E-192
				22Ω	1MΩ	±0.25%	
				43Ω	1MΩ	±0.1%	
MMP52V	1/2W	300V	500V	10Ω	1MΩ	±0.5%	E-24/ E-192
				15Ω	1MΩ	±0.25%	
				33Ω	1MΩ	±0.1%	

## ■ POWER DERATING CURVE



# MMP(V) - Metal Film MELF Precision Resistor, Vehicle Grade

Quality • Reliability  
Cost-Down via Innovation.

MMP(V)

## ■ PART NUMBER

Example: MMP52VB2K61TKQTR2K0

MMP52V	B	2K61	TKQ	TR2K0
Type	Tolerance*	Resistance	TC*	Packaging
	B (0.1%) C (0.25%) D (0.5%)	2.61KΩ <b>4-character code</b> containing - 3 significant digits 1 letter multiplier  <b>OHM MULTIPLIER</b> R = 1 K = 10 <sup>3</sup> M = 10 <sup>6</sup> G = 10 <sup>9</sup>	25ppm <b>3-character code</b>  TKM=±5PPM/°C TKN=±10PPM/°C TKP=±15PPM/°C TKQ=±25PPM/°C TKR=±50PPM/°C	<b>5-character code</b> TR = Tape Reel (pieces per reel)  <u>MMP204V</u> 3K0 = 3,000 6K0 = 6,000 10K = 10,000  <u>MMP52V</u> 2K0 = 2,000 6K0 = 6,000 10K = 10,000

\* Listed values may not be applicable across product types or to all resistance values. Please check with us before placing order.  
Please check with us before placing order. \*\*upon request

## ■ TECHNICAL SUMMARY

Characteristics	Limits	
Operating Temperature Range, °C	-55 ~ +155	
Temperature Coefficient, PPM / °C*	±5, ±10, ±15, ±25, ±50 (See below for availability)	
Dielectric Withstanding Voltage, VAC or DC	MMP204V	300
	MMP52V	500
Insulation Resistance, MΩ	>10 <sup>4</sup>	
Film Temperature	155°C	
Failure Rate, pcs/109 device hours	<1.5	
Tin Whisker (JESD201 Temperature Cycling & High Temp. /Humidity Storage), μm	<5	

\* Not applicable to all resistance values. Please check with us regarding the PPM of specific resistance value(s).

## ■ TEMPERATURE COEFFICIENT AVAILABILITY

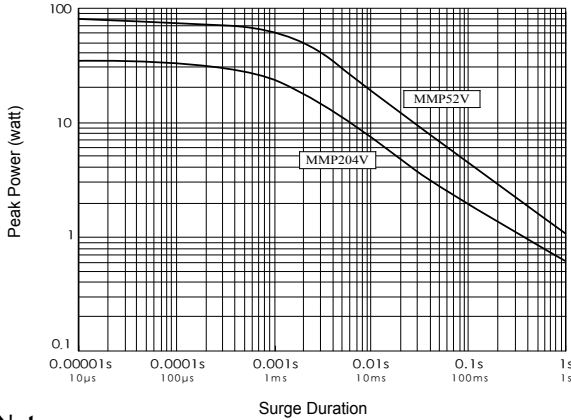
Specifications			
TC	Tolerance	Resistance Values Available	
		MMP204V	MMP52V
±5 PPM/°C	±0.5%	100Ω-10KΩ	75Ω-15KΩ
	±0.25%		
	±0.1%		
±10, ±15 PPM/°C	±0.5%	10Ω-330KΩ	10Ω-680KΩ
	±0.25%	22Ω-330KΩ	15Ω-510KΩ
	±0.1%	43Ω-330KΩ	33Ω-510KΩ
±25, ±50PPM/°C	±0.5%	10Ω-1MΩ	10Ω-1MΩ
	±0.25%	22Ω-1MΩ	15Ω-1MΩ
	±0.1%	43Ω-1MΩ	33Ω-1MΩ

## ■ PERFORMANCE SPECIFICATIONS

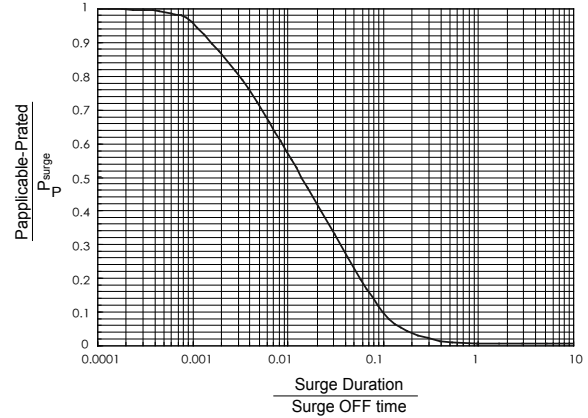
Characteristics	Test Conditions	Limits	
Short Time Overload	<b>IEC 60115-1 4.13</b> 5 seconds 2.5x rated voltage (not over max. overload voltage)	±0.25%	
Load Life In Humidity	<b>IEC 60115-1 4.24</b> 56 days rated load (not over max. working voltage) at (40±2)°C and (93±3)% relative humidity	10Ω to 332KΩ	± 0.5%
		>332KΩ	± 0.75%
Periodic Electric Overload	<b>IEC 60115-1 4.39</b> 3.9x rated voltage (not over max. overload voltage) with 0.1s ON, 2.5s OFF for 1,000 cycles	± 0.5%	
Resistance To Soldering Heat	<b>IEC 60115-1 4.18.2</b> Dip the resistor into a solder bath measured (260±5)°C and hold it for a 10±1 seconds	± 0.5%	
Solderability	<b>IEC 60115-1 4.17.2</b> Solder area covered after (235±3)°C/(2±0.2) seconds with flux applied	>95%	
Mechanical Shock	<b>AEC-Q200 REV D. Stress NO.13 (refer to MIL-STD-202 Method 213 Condition C)</b> Three shocks in each direction shall be applied along the three mutually perpendicular axes of the test specimen. Peak value: 100 g's Duration: 6 ms Velocity change: 12.3 ft/s Waveform: Half sine	±0.5%	
Vibration	<b>AEC-Q200 REV D. Stress NO.14 (refer to MIL-STD-202 Method 204)</b> 5 g's for 20 min., 12 cycles each of 3 orientations Test from 10 - 2,000 Hz.	±0.5%	
Load Life	<b>IEC 60115-1 4.25.1</b> Rated load (not over max. working voltage) 1,000 hours with 1.5 hours ON, 0.5 hours OFF, at (70±2)°C <b>AEC-Q200 REV D. Stress NO. 3 (refer to MIL-STD-202 Method 108)</b> Condition D Steady State TA=125°C at derated continuous working voltage. Measurement at 24±4 hours after test conclusion.	10Ω to 332KΩ	±0.5%
		>332KΩ	±0.75%
Load Life In Humidity (accelerated mode)	<b>IEC 60115-1 4.37/ AEC-Q200 REV D. Stress NO. 7 (refer to MIL-STD-202 Method 103)</b> 1,000 hours at 85°C and 85% relative humidity with 0.1x rated voltage (not over 100V)	10Ω to 10KΩ	±0.75%
		10KΩ to 332KΩ	±1.5%
		>332KΩ	±2.5%
Thermal Endurance	<b>IEC 60115-1 4.25.3</b> 1,000 hours at 85°C without load <b>AEC-Q200 REV D. Stress NO. 3 (refer to MIL-STD-202 Method 108)</b> 1,000 hours at 125°C without load	± 0.25%	
		10Ω to < 332KΩ	± 0.5%
Thermal Shock	<b>IEC 60115-1 4.19</b> -55°C 30minutes, +155°C 30 minutes, 5 cycles <b>AEC-Q200 REV D. Stress NO. 4 (refer to JESD22 Method JA-104)</b> -55°C 30minutes, +125°C 30 minutes, 1,000 cycles 30min maximum dwell time at each temperature extreme. 1min. Maximum transition time.	± 0.25%	
		10 Ω to 332KΩ	± 0.5%
		>332KΩ	± 0.75%
Single pulse high voltage overload	<b>IEC 60115-1 4.27</b> 10 pulses of 10/700µs at 10x rated voltage (not over max. overload voltage) with interval of 60 sec.	± 0.5%	
Electrostatic discharge (Human body model)	<b>IEC 60115-1 4.38</b> 3 positive & 3 negative discharges with 4KV source	± 1.0%	
Climatic test	<b>IEC 60115-1 4.23</b> 4.23.2 - dry heat: 16 hours 155°C 4.23.3 - damp heat: 24 hours 55°C with 95% relative humidity 4.23.4 - cold: 2 hours -55°C 4.23.5 - negative air pressure: 2 hour 8.5KPa at (25°C±10)°C 4.23.6 - damp heat cyclic: 5 days 55°C with 95% relative humidity 4.23.7 - DC load: rated voltage at -55°C and 155°C each 1 Min.	± 1.0%	
Bending test	<b>IEC 60115-1 4.33</b> Pressing depth 2mm, 3 times	± 0.25%	
Flammability	<b>IEC 60115-1 4.35</b> Needle flame test 10s	No burning after 30s	

Quality • Reliability  
Cost-Down via Innovation.

## ■ SINGLE SURGE PERFORMANCE



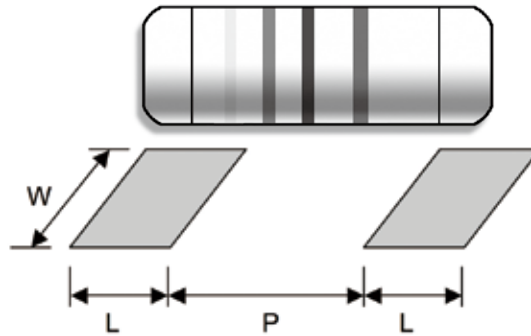
## ■ SURGE POWER DERATING CURVE



### Notes:

- SINGLE SURGE PERFORMANCE graph is good for NON REPETITIVE applications operating in an ambient temperature of 70°C or less. For temperatures above 70°C, the graph power must be derated further linearly down to zero at 155°C.
- To determine applicable surge power in continuous-surge applications:
  1. Identify allowable duration and peak power  $P_{surge}$  of single surge;
  2. Determine ratio of surge duration/surge OFF time in application;
  3. Calculate  $P_{applicable}$  backwardly according to Y-axis of SURGE POWER DERATING CURVE.

## ■ SUGGESTED PAD LAYOUT



Type	Soldering Mode	Pad Length (L, mm, Min.)	Pad Spacing (P, mm)	Pad Width (W, mm, Min.)
MMP204V	Reflow	1.3	1.6 ± 0.1	1.6
	Wave	1.5	1.5 ± 0.1	1.8
MMP52V	Reflow	2.0	3.0 ± 0.1	3.0
	Wave	2.5	3.0 ± 0.1	3.0

For better heat dissipation / lower heat resistance, increase W & L.

## ■ COVER TAPE PEELING SPECIFICATION

Recommended peeling force: 50gf±5gf

